

# 60V Normally Open (1-Form-A) Optical MOSFET Relay

### **General Features**

- ➤ Low-level off State Leakage Current
- ➤ No Moving Parts
- Fast Switching Speed
- > 1500 Vrms Input/Output Isolation
- ➤ SOP Package 4 Pin Type in Miniature Design
- ➤ Highly Efficient GaAlAs Infrared LED and Reliability MOSFETs

App	plica	ation
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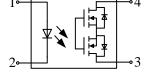
- > Telecommunications
- Measurement Equipment
- > Industrial Automation
- Control Equipment
- ➤ New Energy Vehicles

V <sub>OFF</sub>	I <sub>ON</sub>	R <sub>ON(TYP.)</sub>
60V	0.8A	$0.4\Omega$

SOP-4



(Unit: mm)



- LED Anode
  - 2. LED Cathode
  - 3. Drain (MOSFET)
  - 4. Drain (MOSFET)

## **Ordering Information**

Part Number	Package	Marking	Packing Quantity
AKJ82C06ASSR	SOP-4	82C06ASSR	2000pcs/Reel

## **Absolute Maximum Ratings**

T<sub>A</sub>=25°C unless otherwise specified

Item		Symbol	Note	Value	Unit
	LED Forward Current	$I_{\mathrm{F}}$		50	mA
	LED Pulse Forward Current	$I_{FP}$	f=100Hz, duty=1%	1000	mA
Input	LED Reverse Voltage	$V_R$		5	V
	LED Power Dissipation	P <sub>D</sub>		75	mW
	LED Junction Temperature	$T_J$		100	°C
	Off-state Output Terminal Voltage	V <sub>OFF</sub>	AC Peak or DC	60	V
	On-state Current	I <sub>ON</sub>		800	mA
Output	On-state Peak Current	I <sub>ONP</sub>	100ms (1 pulse)	1.5	A
	Output Power Dissipation	Po		450	mW
	Junction Temperature	$T_J$		100	°C
Total Power Dissipation		$P_{T}$		500	mW
Storage Temperature		$T_{stg}$		-40 to 100	°C
Operating Temperature		$T_{opr}$		-40 to 85	°C
Lead Soldering Temperature		$T_{\rm sol}$	10s max.	260	°C
Isolation Voltage [1]		BV <sub>IO</sub>	AC, RH≤60%, 60s	1500	Vrms

 $Caution: Stresses\ greater\ than\ those\ listed\ in\ the\ ``Absolute\ Maximum\ Ratings"\ may\ cause\ permanent\ damage\ to\ the\ device.$ 



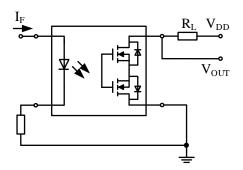
# **Electrical Characteristics**

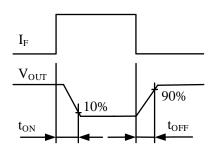
T<sub>A</sub>=25°C unless otherwise specified

Item		Symbol	Min.	Тур.	Max.	Unit	Test Conditions	
	LED Forward Voltage	$V_{F}$		1.3	1.5	V	I <sub>F</sub> =10mA	
	LED Reverse Current	$I_R$			5.0	μΑ	V <sub>R</sub> =5V	
Input	Trigger LED Current	$I_{FT}$		0.8	2.0	mA	I <sub>ON</sub> =100mA	
	Return LED Current	$I_{FC}$		0.35	0.5	mA	I <sub>OFF</sub> =100μA	
	Return LED Voltage	$V_{FC}$	0.7	1		V	I <sub>OFF</sub> =100μA	
Output	On-state Resistance [2]	Ron		0.4	1.0	Ω	I <sub>F</sub> =5mA, I <sub>ON</sub> =100mA	
	Off-state Leakage Current	I <sub>OFF</sub>			1000	nA	V <sub>OFF</sub> =60V	
	Output Capacitance	Cout		50		pF	V <sub>OUT</sub> =0V, f=1MHz	
Transmission	Turn-on Time [3]	Ton		250	1000	μs	I <sub>F</sub> =5mA, I <sub>ON</sub> =100mA	
	Turn-off Time [3]	$T_{OFF}$		80	500	μs		
	Capacitance Input to Output	C <sub>IO</sub>		0.47		pF	V <sub>IO</sub> =0V, f=1MHz	
Coupled	Isolation Resistance	R <sub>IO</sub>	1010			Ω	DC=500V	
	Isolation Voltage	BV <sub>IO</sub>	1500			Vrms	AC, 60s	

#### NOTE:

- [1] LED pins are shorted together. Detector pins are also shorted together.
- [2] Measurement Taken within 1 Second of On-time.
- [3] Switching Time Test Circuit.





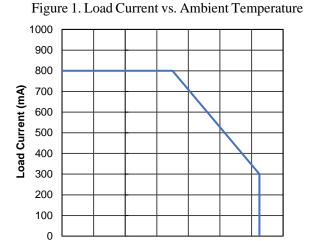


## **Typical Characteristics**

-20

-40

0



20

Figure 3. Swtching Time vs. Ambient

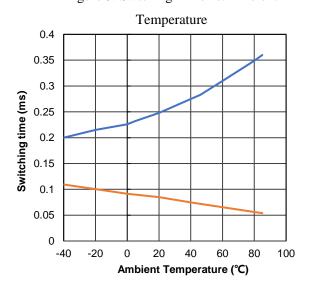
Ambient Temperature (°C)

40

60

80

100



100 Off-state Current (nA) 10 1 0.1

20

40

Ambient Temperature (°C)

60

80

100

Figure 5. Off-state Current vs. Ambient

**Temperature** 

Figure 2. On-state Resistance vs. Ambient Temperature

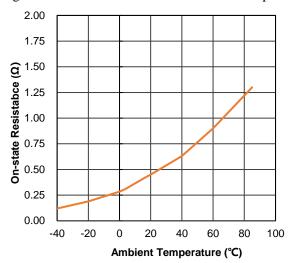


Figure 4. Trigger LED Current vs. Ambient

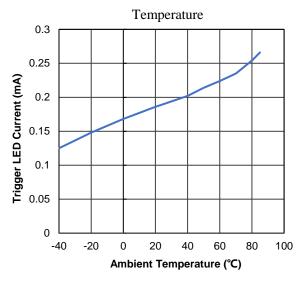
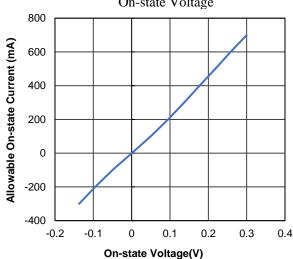


Figure 6. Allowable On-state Current vs. On-state Voltage



-20

0

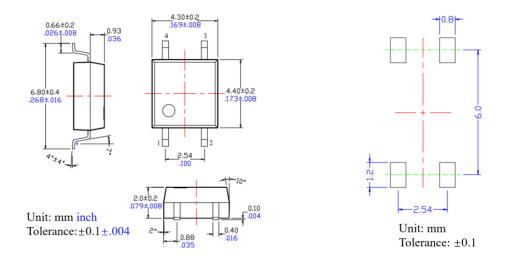
0.01

-40

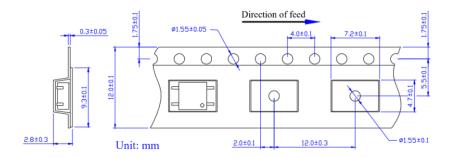


# **Package Dimensions**

### **SOP - 4**



### **Tape dimensions**





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